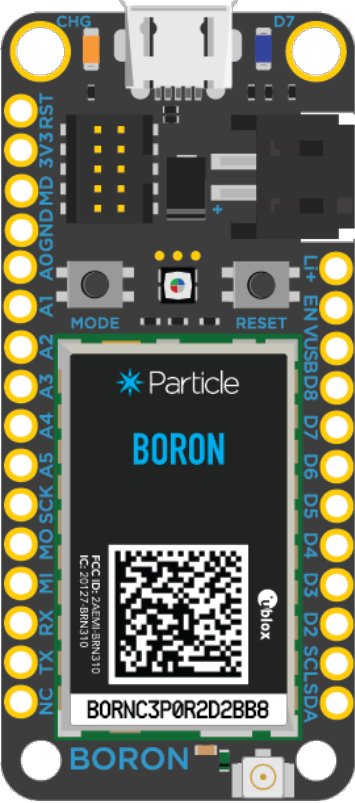


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Boron Datasheet



Functional description

OVERVIEW

The Boron is a powerful LTE Cat M1 or 2G/3G enabled development kit that supports cellular networks and Bluetooth LE (BLE). It is based on the Nordic nRF52840 and has built-in battery charging circuitry so it's easy to connect a Li-Po and deploy your local network in minutes.

The Boron is great for connecting existing projects to the Particle Device Cloud where Wi-Fi is missing or unreliable.

The BRN404X model (LTE Cat M1, North America) can be found in the [Boron BRN404X datasheet](#).

FEATURES

Features - BRN402, BRN404 (Boron LTE)

- The BRN402 and BRN404 have been deprecated, replacement is the B404X. See the [Supply Secure FAQ](#) for more information.
- u-blox SARA-R410M-02B-00 or R410M-02B-03 LTE modem
- LTE Cat M1 module
- Support for United States, Canada, and Mexico only
- 3GPP Release 13 LTE Cat M1
- LTE Cat M1 bands: 2, 4, 5, 12, 13
- Embedded Particle EtherSIM (BRN404)
- Embedded Particle SIM (BRN402)

Features - BRN314, BRN310 (Boron 2G/3G)

- The BRN314 and BRN310 have been deprecated. See the [Supply Secure FAQ](#) for more information.
- u-blox SARA U201 2G/3G modem
- HSPA/GSM with global hardware and SIM support
- Bands 800/850/900/1900/2100 MHz
- 3GPP Release 7
- Embedded Particle EtherSIM (BRN314)
- Embedded Particle SIM (BRN310)

Features - all models

- Nordic Semiconductor nRF52840 SoC
- ARM Cortex-M4F 32-bit processor @ 64MHz
- 1MB flash, 256KB RAM
- Bluetooth 5: 2 Mbps, 1 Mbps, 500 Kbps, 125 Kbps
- Supports DSP instructions, HW accelerated Floating Point Unit (FPU) and encryption functions
- Up to +8 dBm TX power (down to -20 dBm in 4 dB steps)
- NFC-A tag
- On-board additional 4MB SPI flash
- 20 mixed signal GPIO (6 x Analog, 8 x PWM), UART, I2C, SPI
- Micro USB 2.0 full speed (12 Mbps)
- Integrated Li-Po charging and battery connector
- JTAG (SWD) Connector
- RGB status LED
- Reset and Mode buttons
- Dual SIM support: Nano 4FF and MFF2

- On-board PCB antenna
- U.FL connector for external antenna
- Meets the Adafruit Feather [specification](#) in dimensions and pinout
- FCC and PTCRB certified
- RoHS compliant (lead-free)

MODEL COMPARISON

	BRN404X	BRN404	BRN402	BRN313	BRN310
Region	NorAm	NorAm	NorAm	Global	Global
Technology	LTE Cat M1	LTE Cat M1	LTE Cat M1	2G/3G	2G/3G
EtherSIM	✓	✓		✓	
Supply Secure	✓				
Lifecycle	GA	Deprecated	Deprecated	NRND	NRND

- EtherSIM devices generally have a larger number of carriers and more may be added in the future
- NorAm: North America (United States, Canada, and Mexico)
- Global 2G/3G devices not recommended in the United States due to the impending shutdown of 2G/3G networks
- NRND: Not recommended for new designs
- See the [Carrier list](#) for specific carrier and country compatibility
- See the [Supply secure FAQ](#) for more information
- See [Lifestyle stages](#) for more information

DEVICE OS SUPPORT

It is recommended that you use the latest version in the 4.x LTS release line with Boron models.

While the Boron 2G/3G (BRN314 and BRN310) and Boron LTE (BRN404 and BRN402) can use an older version of Device OS:

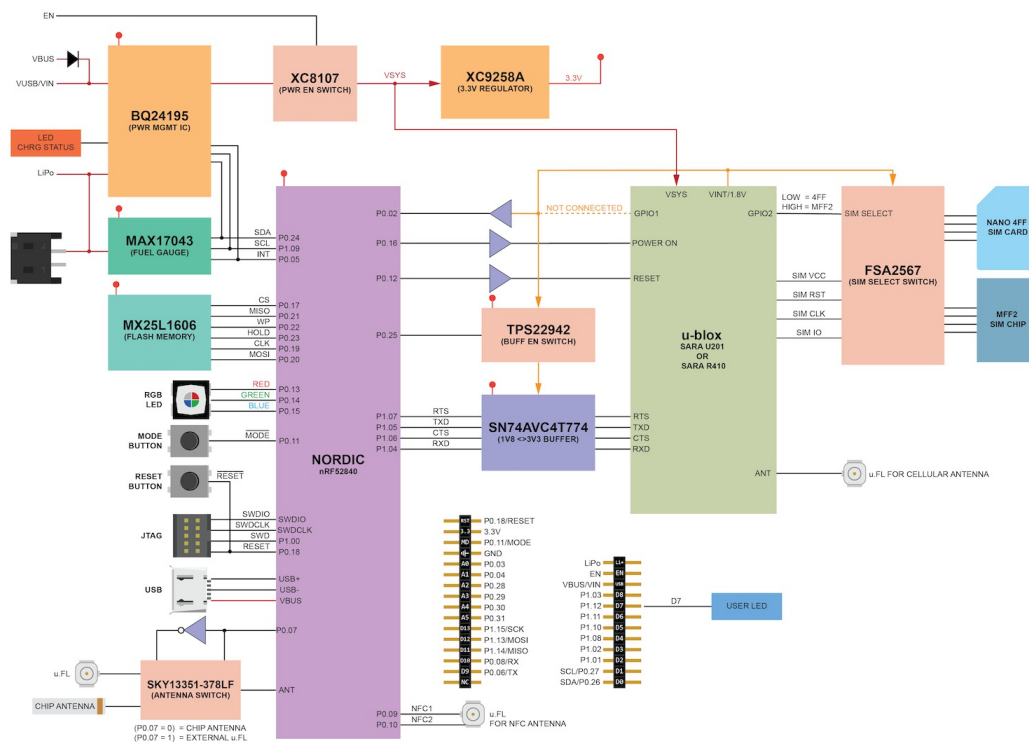
- Device OS 3.x is a developer preview release and has reached its end-of-support date.
- The 2.x LTS release line is in the Extended Support and Maintenance (ESM) window and will stop being supported in 2024.
- Earlier versions of Device OS have reached their end-of-support dates.

The BRN404X requires a minimum of Device OS 4.0.0, so if you have a mixed fleet of devices that contains both BRN404 and BRN404X devices, we recommend that you upgrade all devices in the fleet to use a consistent version of Device OS.

For information on upgrading Device OS, see [Version information](#). For the latest version shipped from the factory, see [Manufacturing firmware versions](#) page. See also [Long Term Support \(LTS\) releases](#).

Interfaces

BLOCK DIAGRAM



POWER

USB PORT

The USB port is the easiest way to power up the Boron. Please make sure that the USB port is able to provide at least 500mA. Power from the USB is regulated down to 3.3V by the on-board Torex XC9258A step-down regulator.

For powering the Boron 2G/3G version, you'll either need a USB port that is able to support 2A current, or have the LiPo battery plugged in when powering over USB. This is because the on-board u-blox modem can consume up to 1.8A peak current when operating in 2G mode. The Boron will intelligently source power from the USB most of the time and keep the battery charged. During peak current requirements, the additional power will be sourced from the battery. This reduces the charge-discharge cycle load on the battery, thus improving its longevity.

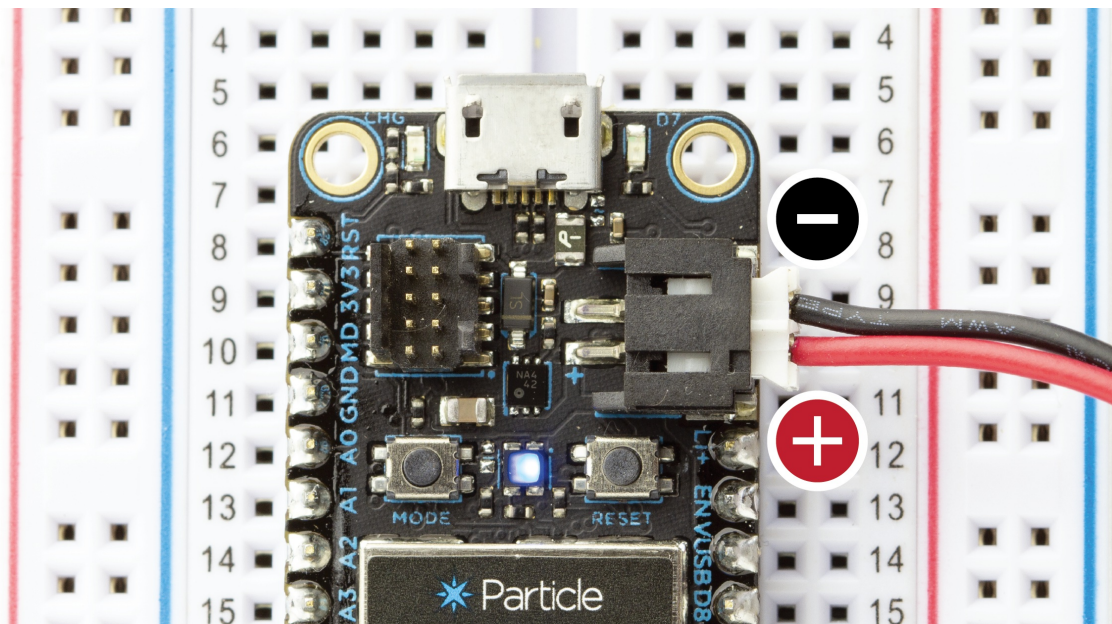
VUSB PIN

The pin is internally connected to the VBUS of the USB port. The nominal output should be around 4.5 to 5 VDC when the device is plugged into the USB port and 0 when not connected to a USB source. You can use this pin to power peripherals that operate at such voltages. Do not exceed the current rating of the USB port, which is nominally rated to 500mA.

LiPo

If you want to make your projects truly wireless, you can power the device with a single cell LiPo (3.7V). The Boron has an on-board LiPo charger that will charge and power the device when USB source is plugged in, or power the device from the LiPo alone in the absence of the USB.

NOTE: Please pay attention to the polarity of the LiPo connector. Not all LiPo batteries follow the same polarity convention!



Li+ pin

This pin is internally connected to the positive terminal of the LiPo connector. You can connect a single cell LiPo/Lithium Ion or a DC supply source to this pin for powering the Boron. Remember that the input voltage range on this pin is 3.6 to 4.2 VDC.

For the Boron 2G/3G version, make sure that the external DC supply is able to support 2A peak current requirements.

3V3 PIN

This pin is the output of the on board 3.3V step-down switching regulator (Torex XC9258A). The regulator is rated at 1000mA max. When using this pin to power other devices or peripherals remember to budget in the current requirement of the Boron first. Unlike the Photon, this pin *CANNOT* be used to power the Boron.

EN pin

The **EN** pin is not a power pin, per se, but it controls the 3V3 and cellular modem power via a load switch (XC8107, U2). The EN pin is pulled high by a 100K resistor to PMIC_SYS (3.8V), which is powered by VUSB, the micro USB connector, or the LiPo battery. Because the pull-up can result in voltages above 3.3V you should never directly connect EN to a 3.3V GPIO pin. Instead, you should only pull EN low, such as by using an N-channel MOSFET or other open-collector transistor.

The EN pin can force the device into a deep power-down state where it uses very little power. It also can be used to assure that the device is completely reset, similar to unplugging it, with one caveat:

If using the EN pin to deeply reset the device, you must be careful not to allow leakage current back into the nRF52 MCU by GPIO or by pull-ups to 3V3. If you only power external devices by 3V3 you won't run into this, as 3V3 is de-powered when EN is low.

However, if you have circuitry that is powered by a separate, external power supply, you must be careful. An externally powered circuit that drives a nRF52 GPIO high when EN is low can provide enough current to keep the nRF52 from powering down and resetting. Likewise, a pull-up to an external power supply can do the same thing. Be sure that in no circumstances can power be supplied to the nRF52 when 3V3 is de-powered.

[See the power supply schematic](#), below, for more information.

ANTENNA

There are two radios on the Boron. A BLE radio (nRF52840) and a cellular radio (u-blox). For the cellular radio, we have provided a u.FL connector to plug in the cellular antenna. This is required if you wish to use the cellular connectivity.

There are two options for the BLE antenna on the Boron. It comes with an on-board PCB antenna which is selected by default in the device OS and a u.FL connector if you wish to connect an external antenna. If you wish to use the external antenna, you'll need to issue an appropriate command in the firmware.

FCC APPROVED ANTENNAS

BLE

The following antenna is optional, as the Boron comes with an on-board chip antenna for BLE. It can be purchased in the [Particle online store](#).

Particle Device	Frequency	Antenna Type	Manufacturer	MFG. Part #	Gain
Boron	2400-2500 MHz	PCB Antenna	Particle	ANT-FLXV2	2.0dBi peak

Cellular

Particle Device	Frequency	Antenna Type	Manufacturer	MFG. Part #	Gain
Boron	698-3000 MHz	PCB Antenna	Taoglas	FXUB63.07.0150C	5.00dBi peak

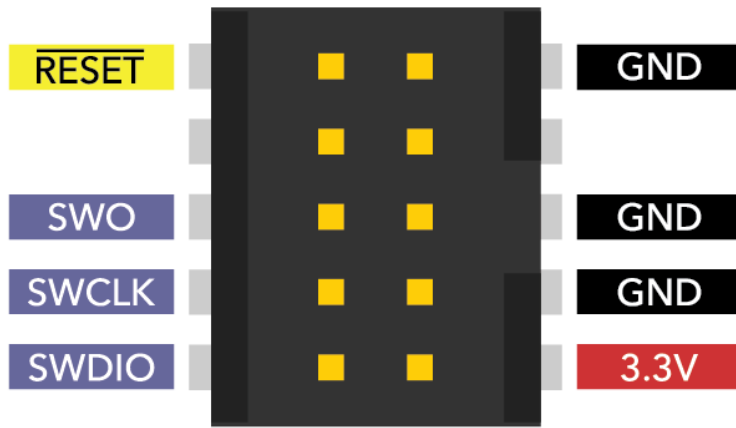
PERIPHERALS AND GPIO

Peripheral Type	Qty	Input(I) / Output(O)
Digital	20	I/O
Analog (ADC)	6	I
UART	1	I/O
SPI	1	I/O
I2C	2	I/O
USB	1	I/O
PWM	8	O

Note: All GPIOs are only rated at 3.3VDC max.

SWD

The Boron has a dedicated 10 pin debug connector that exposes the SWD interface of the nRF52840. This interface can be used to debug your code or reprogram your Boron bootloader, device OS, or the user firmware using any standard SWD tools including our Gen 3 Debugger.



Memory map

NRF52840 FLASH LAYOUT OVERVIEW

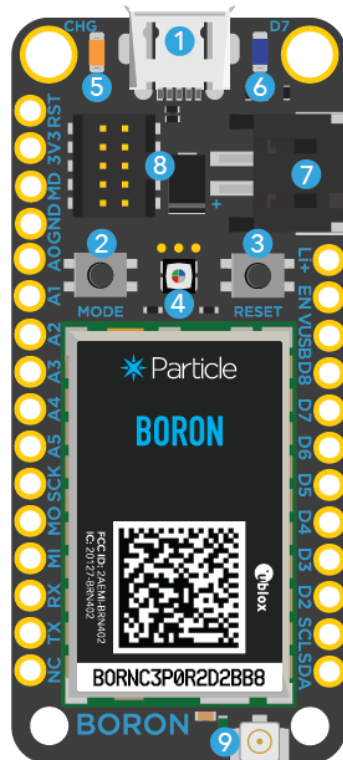
- Bootloader (48KB, @0xF4000)
- User Application
 - 256KB @ 0xB4000 (Device OS 3.1 and later)
 - 128KB @ 0xD4000 (Device OS 3.0 and earlier)
- System (656KB, @0x30000)
- SoftDevice (192KB)

EXTERNAL SPI FLASH LAYOUT OVERVIEW (DFU OFFSET: 0X80000000)

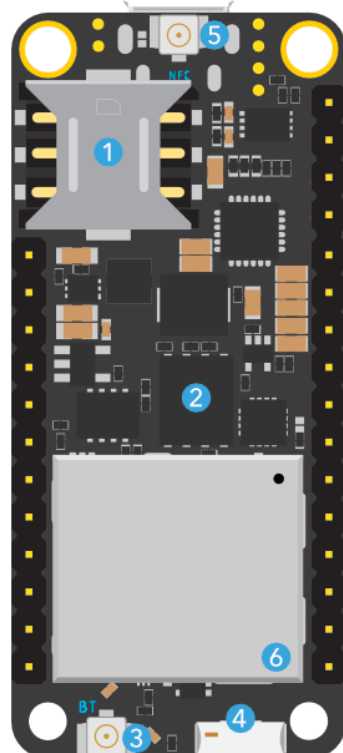
- OTA (1500KB, @0x00289000)
- Reserved (420KB, @0x00220000)
- FAC (128KB, @0x00200000)
- LittleFS (2M, @0x00000000)

Pins and button definitions

PIN MARKINGS

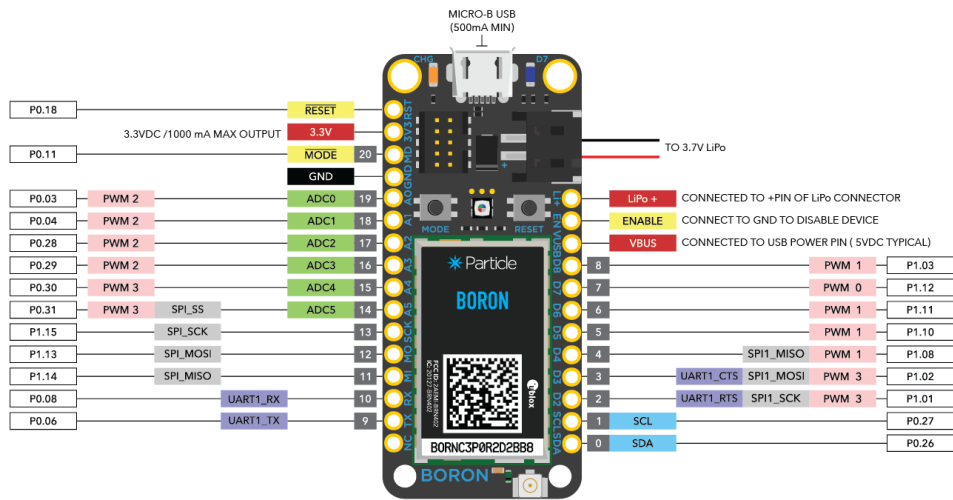


- 1 USB
- 2 MODE BUTTON
- 3 RESET BUTTON
- 4 RGB STATUS LED
- 5 CHARGE STATUS LED
- 6 USER LED (ON D7)
- 7 LiPo BATT CONNECTOR
- 8 DEBUG CONNECTOR (SWD)
- 9 u.FL CONNECTOR FOR CELLULAR ANTENNA (REQUIRED)



- 1 NANO SIM HOLDER
- 2 ON-BOARD MFF2 SIM
- 3 u.FL CONNECTOR FOR EXTERNAL MESH ANTENNA (OPTIONAL)
- 4 ON-BOARD CHIP ANTENNA FOR MESH
- 5 u.FL CONNECTOR FOR NFC ANTENNA
- 6 RF SHIELD

PINOUT DIAGRAM



PWM 0	GROUP 0 PWM PINS	ADC	ANALOG TO DIGITAL INPUT PINS	UART1	SERIAL COMMUNICATION PINS (SERIAL1)
PWM 1	GROUP 1 PWM PINS	SPI	SPI COMMUNICATION PINS (SPI)	SPI1	SPI COMMUNICATION PINS (SPI1)
PWM 2	GROUP 2 PWM PINS	SDA/SCL	I2C COMMUNICATION PINS (WIRE)		
PWM 3	GROUP 3 PWM PINS	PX.XX	nRF52840 PIN NAMES		

v1.0

You can download a high resolution [PDF version of the pin out here.](#)

PIN DESCRIPTION

Pin	Description
Li+	This pin is internally connected to the positive terminal of the LiPo battery connector.
VUSB	This pin is internally connected to the USB (+ve) supply.
3V3	This pin is the output of the on-board 3.3V regulator.
GND	System ground pin.
EN	Device enable pin is internally pulled-up. To disable the device, connect this pin to GND.
RST	Active-low system reset input. This pin is internally pulled-up.
MD	This pin is internally connected to the MODE button. The MODE function is active-low.
RX	Primarily used as UART RX, but can also be used as a digital GPIO.
TX	Primarily used as UART TX, but can also be used as a digital GPIO.
SDA	Primarily used as data pin for I2C, but can also be used as a digital GPIO.
SCL	Primarily used as clock pin for I2C, but can also be used as a digital GPIO.
MO,MI,SCK	These are the SPI interface pins, but can also be used as a digital GPIO.
D2-D8	These are generic GPIO pins. D2-D8 are PWM-able.
A0-A5	These are analog input pins that can also act as standard digital GPIO. A0-A5 are PWM-able.

System RGB LED

For a detailed explanation of different color codes of the RGB system LED, please take a look [here](#).

Charge status LED

State	Description
ON	Charging in progress
OFF	Charging complete
Blink at 1Hz	Fault condition ^[1]
Rapid blinking	Battery disconnected ^[2]

Notes:

^[1] A fault condition can occur due to several reasons, for example, battery over/under voltage, temperature fault or safety timer fault. You can find the root cause by reading the fault register of the power management IC in firmware.

^[2] You can stop this behavior by either plugging in the LiPo battery or by disabling charging using firmware command: `PMIC().disableCharging();`.

Technical specifications

ABSOLUTE MAXIMUM RATINGS ^[1]

Parameter	Symbol	Min	Typ	Max	Unit
Supply Input Voltage	V _{IN-MAX}			+6.2	V
Battery Input Voltage	V _{LiPo}			+6.5	V
Supply Output Current	I _{3V3-MAX-L}			1000	mA
Storage Temperature	T _{stg}	-30		+75	°C
ESD Susceptibility HBM (Human Body Mode)	V _{ESD}			1	kV

^[1] Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Typ	Max	Unit
LiPo Battery Voltage	V _{LiPo}	+3.3		+4.4	V
Supply Input Voltage	V _{3V3}	+3.0	+3.3	+3.6	V
Supply Output Voltage	V _{3V3}		+3.3		V
Operating Temperature	T _{op}	-20		+60	°C
Humidity Range Non condensing, relative humidity				95	%

POWER CONSUMPTION (BORON 2G/3G)

Parameter	Symbol	Min	Typ	Peak	Unit
Peak Current, 3G	I _{Li+ pk}			800	mA
Peak Current, 2G	I _{Li+ pk}			1800	mA
Operating Current (uC on, peripherals and radio disabled)	I _{idle}	3.76	3.77	3.79	mA
Operating Current (uC on, cellular on but not connected)	I _{cell_idle}	3.84	25.2	901	mA
Operating Current (uC on, cellular connecting to tower)	I _{cell_conn_twr}	11.6	56.9	579	mA
Operating Current (uC on, cellular connecting to cloud)	I _{cell_conn_cloud}	22.4	97.9	957	mA
Operating Current (uC on, cellular connected but idle)	I _{cell_cloud_idle}	15.6	18.7	84.7	mA
Operating Current (uC on, cellular connected and transmitting)	I _{cell_cloud_tx}	19.5	86.1	981	mA
STOP mode sleep, GPIO wake-up	I _{stop_gpio}	594	631	665	uA
STOP mode sleep, analog wake-up	I _{stop_analog}	579	585	591	uA
STOP mode sleep, RTC wake-up	I _{stop_inrtc}	589	607	630	uA
STOP mode sleep, BLE wake-up, advertising	I _{stop_ble_adv}	17.0	907	2400	uA
STOP mode sleep, BLE wake-up, connected	I _{stop_ble_conn}	443	906	1540	uA
STOP mode sleep, serial wake-up	I _{stop_usart}	589	606	627	uA
STOP mode sleep, cellular wake-up	I _{stop_cell}	6.49	15.6	81.0	mA
ULP mode sleep, GPIO wake-up	I _{ulp_gpio}	160	171	182	uA
ULP mode sleep, analog wake-up	I _{ulp_analog}	166	178	188	uA
ULP mode sleep, RTC wake-up	I _{ulp_inrtc}	163	174	185	uA
ULP mode sleep, BLE wake-up, advertising	I _{ulp_ble_adv}		494	2100	uA
ULP mode sleep, BLE wake-up, connected	I _{ulp_ble_conn}	55.9	515	1090	uA
ULP mode sleep, serial wake-up	I _{ulp_usart}	590	610	634	uA
ULP mode sleep, cellular wake-up	I _{ulp_cell}	6.96	16.4	81.1	mA
HIBERNATE mode sleep, GPIO wake-up	I _{hib_gpio}	139	146	162	uA
HIBERNATE mode sleep, analog wake-up	I _{hib_analog}	139	147	163	uA
Power disabled (EN pin = LOW)	I _{disable}		70	75	uA

¹The min, and particularly peak, values may consist of very short transients. The typical (typ) values are the best indicator of overall power consumption over time. The peak values indicate the absolute minimum capacity of the power supply necessary, not overall consumption.

POWER CONSUMPTION (BORON LTE)

Parameter	Symbol	Min	Typ	Peak	Unit
Peak Current	I_{Li+pk}	120		490	mA
Operating Current (uC on, peripherals and radio disabled)	I_{idle}	3.89	3.90	3.92	mA
Operating Current (uC on, cellular on but not connected)	I_{cell_idle}		5.78	16.9	mA
Operating Current (uC on, cellular connecting to tower)	$I_{cell_conn_twr}$	14.7	58.9	178	mA
Operating Current (uC on, cellular connecting to cloud)	$I_{cell_conn_cloud}$	14.6	53.4	207	mA
Operating Current (uC on, cellular connected but idle)	$I_{cell_cloud_idle}$		17.9	108	mA
Operating Current (uC on, cellular connected and transmitting)	$I_{cell_cloud_tx}$		63.9	184	mA
STOP mode sleep, GPIO wake-up	I_{stop_gpio}	565	575	590	uA
STOP mode sleep, analog wake-up	I_{stop_analog}	565	577	593	uA
STOP mode sleep, RTC wake-up	I_{stop_intrtc}	568	584	602	uA
STOP mode sleep, BLE wake-up, advertising	$I_{stop_ble_adv}$	91.6	885	2210	uA
STOP mode sleep, BLE wake-up, connected	$I_{stop_ble_conn}$	486	866	1440	uA
STOP mode sleep, serial wake-up	I_{stop_usart}	569	587	612	uA
STOP mode sleep, cellular wake-up	I_{stop_cell}		12.2	104	mA
ULP mode sleep, GPIO wake-up	I_{ulp_gpio}		127	137	uA
ULP mode sleep, analog wake-up	I_{ulp_analog}		130	141	uA
ULP mode sleep, RTC wake-up	I_{ulp_intrtc}		128	138	uA
ULP mode sleep, BLE wake-up, advertising	$I_{ulp_ble_adv}$		442	2120	uA
ULP mode sleep, BLE wake-up, connected	$I_{ulp_ble_conn}$		438	1050	uA
ULP mode sleep, serial wake-up	I_{ulp_usart}	568	584	601	uA
ULP mode sleep, cellular wake-up	I_{ulp_cell}		14.2	112	mA
HIBERNATE mode sleep, GPIO wake-up	I_{hib_gpio}	98.7	106	118	uA
HIBERNATE mode sleep, analog wake-up	I_{hib_analog}	99.4	106	120	uA
Power disabled (EN pin = LOW)	$I_{disable}$		70	75	uA

¹The min, and particularly peak, values may consist of very short transients. The typical (typ) values are the best indicator of overall power consumption over time. The peak values indicate the absolute minimum capacity of the power supply necessary, not overall consumption.

RADIO SPECIFICATIONS

Boron has two radio modules, the nRF52 MCU BLE radio, and a cellular module, depending on the model.

Nordic Semiconductor nRF52840 for BLE.

Feature	Description
Operating Frequencies	2360 to 2500 MHz
Output Power	Programmable -20dBm to +8dBm
PLL channel spacing	1 MHz
On the air data rate	125 to 2000 kbps

u-blox SARA-U201 (2G/3G)

Parameter	Value
Protocol stack	3GPP Release 7
MS Class	Class B
Bands	GSM 850 MHz
	E-GSM 900 MHz
	DCS 1800 MHz
	PCS 1900 MHz
Power Class	Class 4 (33 dBm) for 850/900 bands
	Class 1 (30 dBm) for 1800/1900 bands

- Global 2G/3G.
- Not recommended for use in the United States due to the shutdown of 2G and 3G networks in 2022.

u-blox SARA-R410M-02B-00 or R410M-02B-03

Parameter	Value
Protocol stack	3GPP Release 13
RAT	LTE Cat M1 Half-Duplex
LTE FDD Bands	Band 12 (700 MHz)
	Band 28 (700 MHz)
	Band 13 (750 MHz)
	Band 20 (800 MHz)
	Band 5 (850 MHz)
	Band 8 (900 MHz)
	Band 4 (1700 MHz)
	Band 3 (1800 MHz)
	Band 2 (1900 MHz)
Power class	Class 3 (23 dBm)

- LTE Cat M1 for United States, Canada, and Mexico.
- Not all bands are enabled in software by default.
- Particle LTE Cat M1 devices are not certified for use in Europe or other countries that follow EU certification requirements.

I/O CHARACTERISTICS

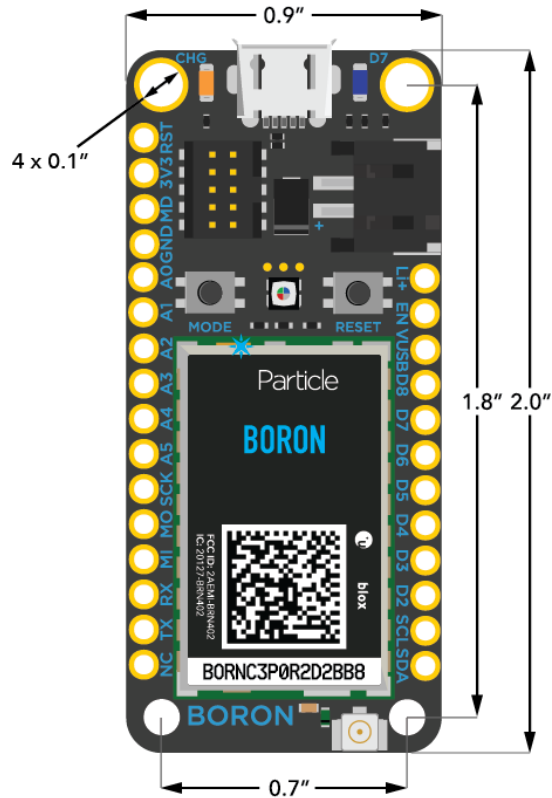
These specifications are based on the nRF52840 datasheet.

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input high voltage	V_{IH}		0.7*3.3	--	3.3	V
Input low voltage	V_{IL}		0		0.3*3.3	V
Current at GND+0.4 V, output set low, high drive	$I_{OL,HDL}$	$V_{3V3} \geq 2.7V$	6	10	15	mA
Current at V_{3V3} -0.4 V, output set high, high drive	$I_{OH,HDH}$	$V_{3V3} \geq 2.7V$	6	9	14	mA
Current at GND+0.4 V, output set low, standard drive	$I_{OL,SD}$	$V_{3V3} \geq 2.7V$	1	2	4	mA
Current at V_{3V3} -0.4 V, output set high, standard drive	$I_{OH,SD}$	$V_{3V3} \geq 2.7V$	1	2	4	mA
Pull-up resistance	R_{PU}		11	13	16	k Ω
Pull-down resistance	R_{PD}		11	13	16	k Ω

GPIO default to standard drive (2mA) but can be reconfigured to high drive (9mA) in Device OS 2.0.0 and later using the `pinSetDriveStrength()` function.

Mechanical specifications

DIMENSIONS AND WEIGHT



- Weight = 10 grams

3D MODELS

3D models of the Boron are available in the [hardware-libraries Github](#) in formats including step, iges, stl, and f3d.

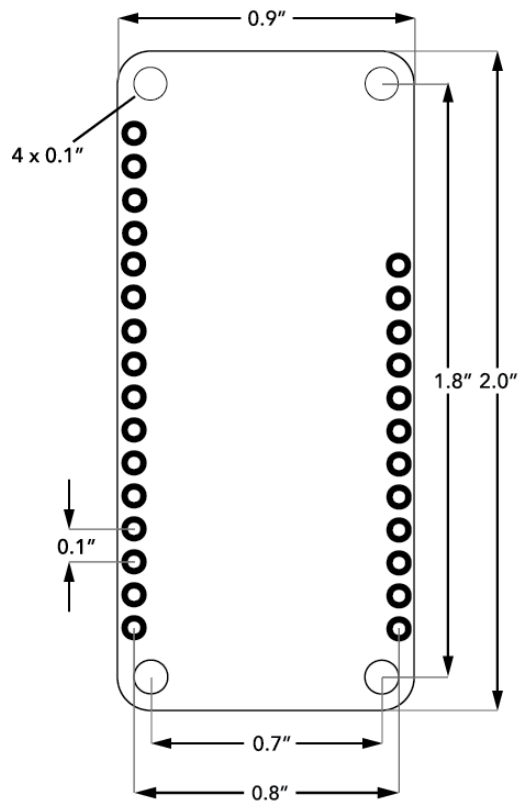
MATING CONNECTORS

The Boron uses two single row 0.1" pitch male header pins. One of them is 16 pin while the other is 12 pin. It can be mounted with matching 0.1" pitch female headers with a typical height of 0.335" (8.5mm). When you search for parts like these it can be difficult to navigate the thousands of parts available online so here are a few good choices for the Boron:

Description	MFG	MFG Part Number
16-pin 0.1" (2.54mm) Female Header	Sullins	PPTC161LFBN-RC
16-pin 0.1" (2.54mm) Female Header	TE	6-535541-4
12-pin 0.1" (2.54mm) Female Header	Sullins	PPTC121LFBN-RC
12-pin 0.1" (2.54mm) Female Header	TE	6-534237-0

Recommended PCB land pattern

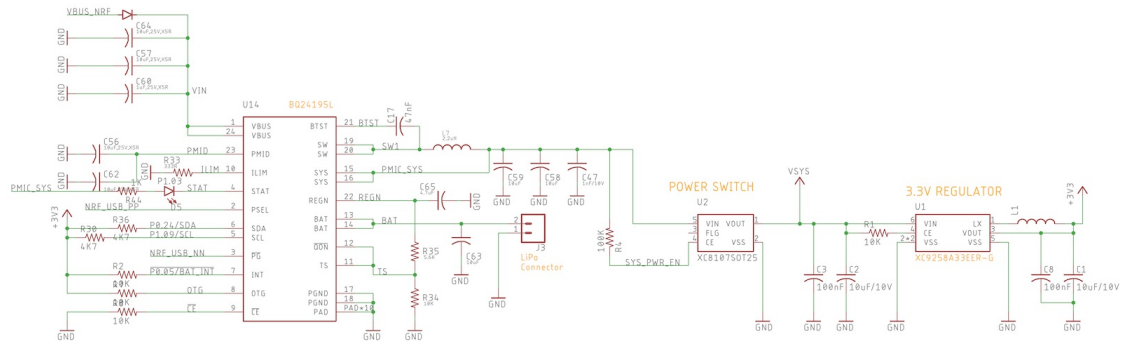
The Boron can be directly soldered onto the PCB or be mounted with the above mentioned female headers.



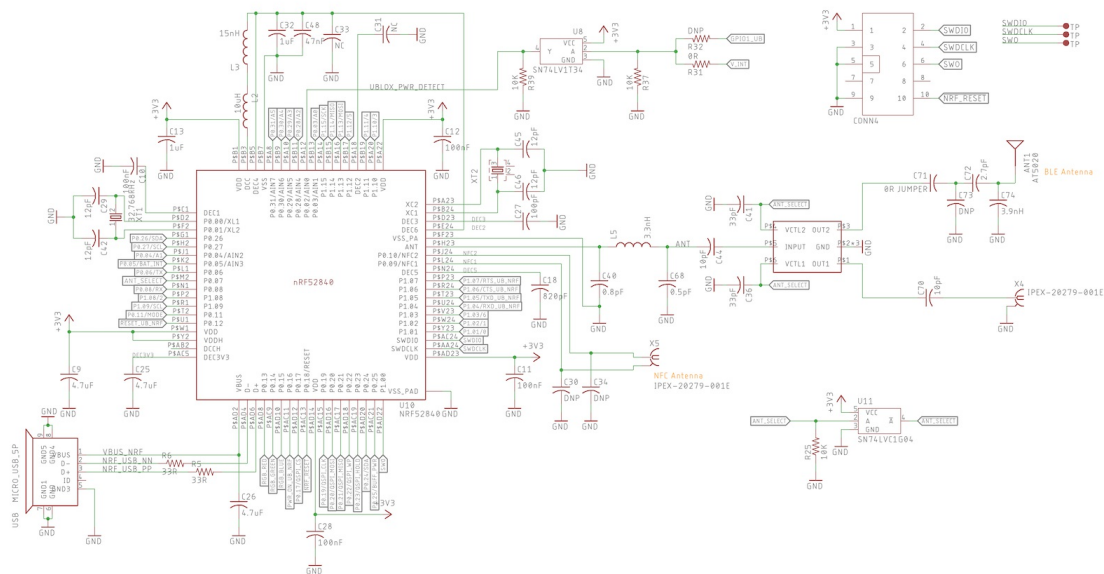
Schematic

The complete schematic and board files are open source and available on Particle's GitHub repository [here](#).

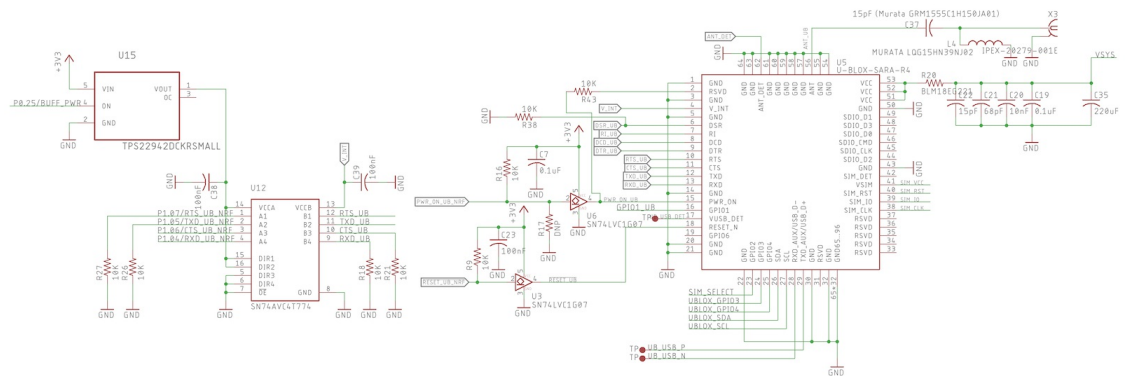
POWER



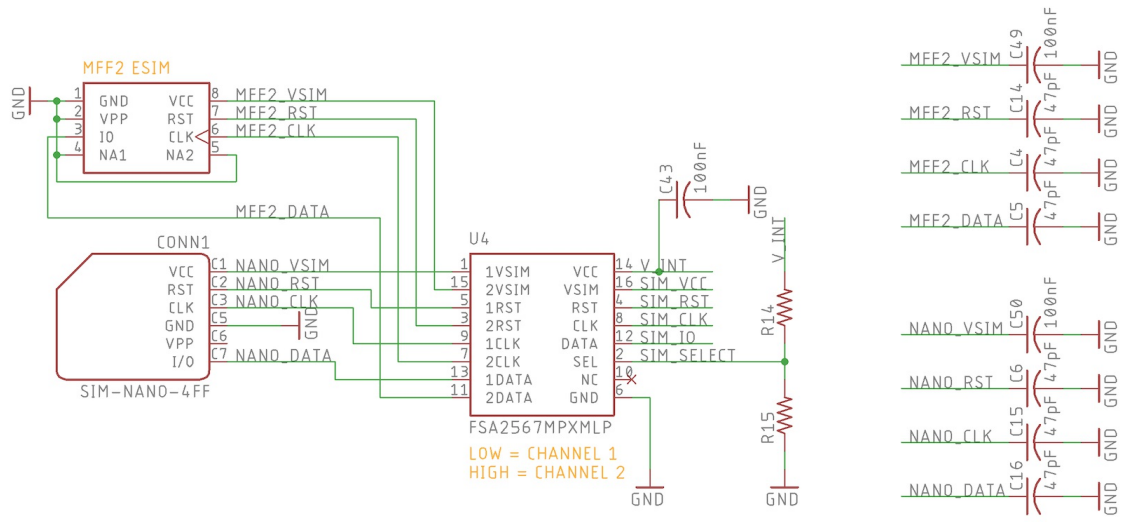
NRF52840



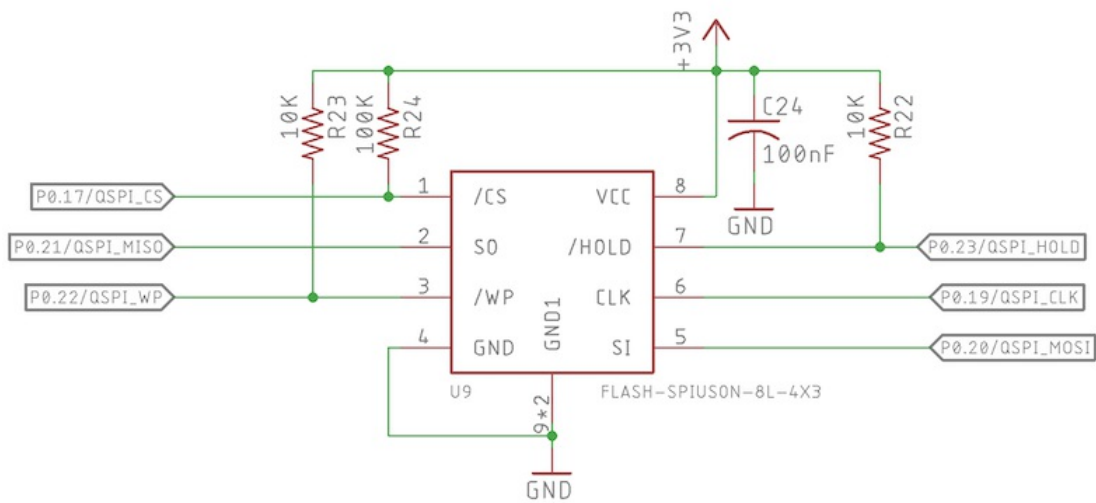
U-BLOX



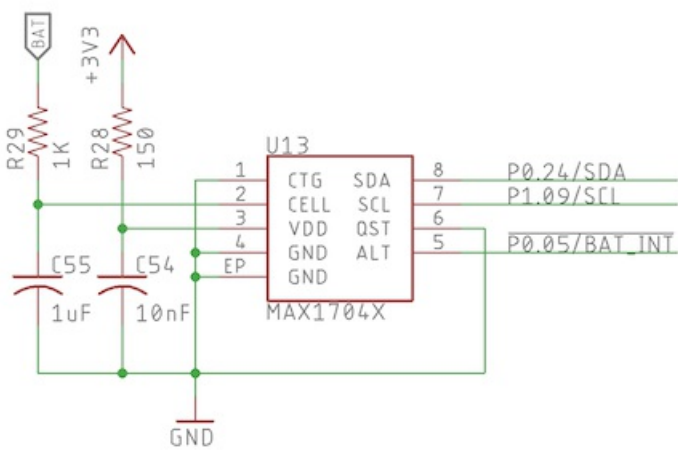
SIM



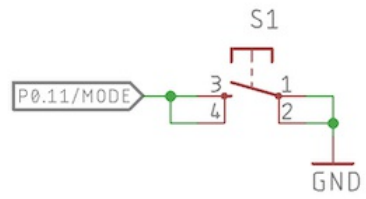
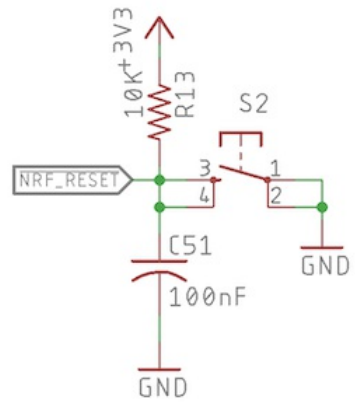
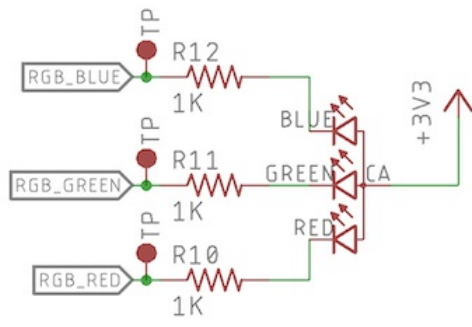
SPI FLASH



FUEL GAUGE



INTERFACES



Assembly

WATER SOLUBLE FLUX

When attaching a Boron to your base board, we recommend using a socket. As there are components on the bottom side of the Boron there is no version available with castellated holes, solder pads, or similar techniques for direct surface mounting.

The pin headers on the bottom of the Boron are not intended to be reflowed using paste-in-hole.

If you decide to wave solder or hand-solder the Boron directly to your base board, water soluble flux should not be used. There are components within the Boron module that are moisture-sensitive, and wash water can get trapped under the RF shields, causing damage.

Use no-clean flux instead if you must solder the Boron module.

CONFORMAL COATINGS

Boron modules should not use a conformal coating to protect the module from water. Some components on the module cannot be coated and would need to be masked off during coating. This will make the coating process difficult to implement and test.

Furthermore, the buttons cannot be protected by using a coating. Using an enclosure that protects both your base board and the Boron module as a single waterproof assembly is recommended instead.

Country compatibility

Country	Model	Technologies	Carriers
Afghanistan	BRN314	2G, 3G	MTN
Albania	BRN314	2G, 3G	ALBtelecom, Telekom, Vodafone
Algeria	BRN314	2G, 3G	Mobilis, Ooredoo
Anguilla	BRN314	2G, 3G	Flow
Antigua and Barbuda	BRN314	2G, 3G	Flow
Argentina	BRN314	2G, 3G	Claro, Movistar, Personal
Armenia	BRN314	2G, 3G	Beeline, Ucom
Aruba	BRN314	2G, 3G	Setar
Austria	BRN314	2G, 3G	3 (Drei), A1, T-Mobile
Azerbaijan	BRN314	2G, 3G	Azercell, Bakcell, NAR Mobile
Bahamas	BRN314	2G, 3G	Aliv, BTC Bahamas
Bahrain	BRN314	2G, 3G	Zain
Bangladesh	BRN314	2G, 3G	Bangalink, GrameenPhone
Barbados	BRN314	2G, 3G	Flow
Belarus	BRN314	2G, 3G	A1
Belgium	BRN314	2G, 3G	Base, Orange, Proximus
Belize	BRN314	3G	Smart
Bolivia	BRN314	2G, 3G	NuevaTel
Bosnia and Herzegovina	BRN314	2G, 3G	BH Telecom, HT Eronet
Brunei	BRN314	3G	DST
Bulgaria	BRN314	2G, 3G	A1, Telenor, Vivacom
Burkina Faso	BRN314	2G, 3G	Orange
Cambodia	BRN314	2G, 3G	Metfone
Canada	BRN404	M1	Bell Mobility, Rogers Wireless, Telus
Canada	BRN404X	M1	Bell Mobility, Rogers Wireless, Telus
Cayman Islands	BRN314	2G, 3G	Flow
Chad	BRN314	2G, 3G	Airtel
Chile	BRN314	2G, 3G	Claro, Entel, Movistar
Colombia	BRN314	2G, 3G	Movistar, Tigo
Congo (Brazzaville)	BRN314	2G, 3G	Airtel
Congo (Kinshasa)	BRN314	2G, 3G	Airtel
Costa Rica	BRN314	2G, 3G	Movistar
Côte d'Ivoire	BRN314	2G, 3G	MTN
Croatia	BRN314	2G, 3G	Hrvatski Telekom, Tele2
Cyprus	BRN314	2G, 3G	Cytamobile-Vodafone, MTN
Czechia	BRN314	2G	O2, T-Mobile, Vodafone
Denmark	BRN314	2G, 3G	3 (Tre), TDC, Telenor, Telia
Dominica	BRN314	2G, 3G	Flow
Dominican Republic	BRN314	2G, 3G	Altice Dominicana, Claro, Viva
Ecuador	BRN314	2G, 3G	Claro, Movistar
Egypt	BRN314	2G, 3G	Etisalat, Orange
El Salvador	BRN314	2G, 3G	Claro, Telefonica

Estonia	BRN314	2G, 3G	Elisa, Tele2, Telia
eSwatini	BRN314	2G, 3G	MTN
Ethiopia	BRN314	2G, 3G	Ethio Telecom
Faroe Islands	BRN314	2G, 3G	Faroese Telecom, Vodafone
Finland	BRN314	2G, 3G	DNA, Elisa, Telia
France	BRN314	2G, 3G	Bouygues, Free Mobile, Orange, SFR
French Guiana	BRN314	2G, 3G	Digicel
Gabon	BRN314	2G, 3G	Airtel
Georgia	BRN314	2G, 3G	Beeline, Geocell
Germany	BRN314	2G, 3G	O2, Telekom, Vodafone
Ghana	BRN314	2G, 3G	AirtelTigo, MTN, Vodafone
Gibraltar	BRN314	2G, 3G	Gibtel
Greece	BRN314	2G	Cosmote, Vodafone, Wind
Grenada	BRN314	2G	Flow
Guadeloupe	BRN314	2G, 3G	Orange
Guatemala	BRN314	2G, 3G	Claro, Movistar
Guinea	BRN314	2G, 3G	MTN
Guinea-Bissau	BRN314	2G, 3G	MTN
Guyana	BRN314	2G	Digicel
Haiti	BRN314	2G, 3G	Digicel
Honduras	BRN314	2G, 3G	Claro, Tigo
Hong Kong	BRN314	2G, 3G	CMHK, CSL, SmarTone
Hungary	BRN314	2G, 3G	Magyar Telekom, Telenor, Vodafone
Iceland	BRN314	2G, 3G	Nova, Siminn, Vodafone
Indonesia	BRN314	2G, 3G	Indosat, Telkomsel, XL Axiata
Ireland	BRN314	2G, 3G	3 (Tre), Meteor, O2, Vodafone
Israel	BRN314	2G, 3G	Hot Mobile, Orange, Pelephone
Italy	BRN314	2G, 3G	TIM, Vodafone, Wind
Jamaica	BRN314	2G, 3G	Digicel, Flow
Japan	BRN314	3G	NTT DoCoMo
Jordan	BRN314	2G, 3G	Zain
Kazakhstan	BRN314	2G, 3G	Beeline, K-Cell
Kenya	BRN314	2G, 3G	Airtel
Kuwait	BRN314	2G, 3G	Viva, Zain
Kyrgyzstan	BRN314	2G, 3G	Beeline
Latvia	BRN314	2G, 3G	Bite, LMT, Tele2
Liechtenstein	BRN314	2G, 3G	Mobilkom, Orange
Lithuania	BRN314	2G, 3G	Bite, Omnitel, Tele2
Luxembourg	BRN314	2G, 3G	Orange, POST, Tango
Malawi	BRN314	2G, 3G	Airtel
Malaysia	BRN314	2G, 3G	Celcom, DiGi, Maxis
Malta	BRN314	2G, 3G	Go Mobile, Vodafone
Mexico	BRN404	M1	AT&T, Telcel
Mexico	BRN404X	M1	AT&T, Telcel
Moldova	BRN314	2G, 3G	Moldcell, Orange

Mongolia	BRN314	2G, 3G	Mobicom, Unitel
Montenegro	BRN314	2G, 3G	Mtel, T-Mobile, Telenor
Mozambique	BRN314	2G, 3G	Vodacom
Myanmar	BRN314	2G, 3G	MPT, Telenor
Namibia	BRN314	2G, 3G	Telecom Namibia
Netherlands	BRN314	2G, 3G	KPN, T-Mobile, Vodafone
Nicaragua	BRN314	2G, 3G	Movistar
Nigeria	BRN314	2G, 3G	9mobile, Airtel, Glo, MTN
Norway	BRN314	2G, 3G	TDC, Telenor, Telia
Pakistan	BRN314	2G, 3G	Mobilink, Telenor, Ufone, Warid
Palestine	BRN314	2G, 3G	Jawwal
Panama	BRN314	2G, 3G	Digicel, Movistar
Papua New Guinea	BRN314	2G, 3G	bmobile
Paraguay	BRN314	2G, 3G	Claro, Personal, Tigo, Vox
Peru	BRN314	2G, 3G	Claro, Entel, Movistar
Philippines	BRN314	2G, 3G	Globe, Smart
Poland	BRN314	2G, 3G	Orange, Play, Plus, T-Mobile
Portugal	BRN314	2G, 3G	NOS, TMN, Vodafone
Puerto Rico	BRN314	2G, 3G	Claro
Qatar	BRN314	2G, 3G	Ooredoo, Vodafone
Romania	BRN314	2G, 3G	Orange, Telekom Romania, Vodafone
Rwanda	BRN314	2G, 3G	Airtel, MTN
Saint Kitts and Nevis	BRN314	2G, 3G	Flow
Saint Lucia	BRN314	2G, 3G	Flow
Saint Vincent and the Grenadines	BRN314	2G, 3G	Flow
Serbia	BRN314	2G, 3G	Telenor, VIP
Sint Maarten	BRN314	2G, 3G	TelCell
Slovakia	BRN314	2G, 3G	O2, Orange, Telekom
Slovenia	BRN314	2G, 3G	A1, Mobitel
South Africa	BRN314	2G, 3G	Cell C, MTN, Vodacom
South Korea	BRN314	3G	KT, SK Telecom
South Sudan	BRN314	2G, 3G	MTN
Spain	BRN314	2G, 3G	Orange, Telefonica, Vodafone, Yoigo
Sri Lanka	BRN314	2G, 3G	Dialog, Mobitel
Suriname	BRN314	2G, 3G	Telesur
Sweden	BRN314	2G, 3G	3 (Tre), Tele2, Telenor, Telia
Switzerland	BRN314	3G	Salt, Sunrise, Swisscom
Taiwan	BRN314	3G	Chunghwa, T Star, Taiwan Mobile
Tajikistan	BRN314	2G, 3G	Beeline, Tcell
Tanzania	BRN314	2G, 3G	Airtel
Thailand	BRN314	2G, 3G	AIS, DTAC, True Move
Trinidad and Tobago	BRN314	2G, 3G	Digicel, TSTT
Tunisia	BRN314	2G, 3G	Orange Tunisie, Tunisie Telecom
Turks and Caicos Islands	BRN314	2G, 3G	Flow
Uganda	BRN314	2G, 3G	Africell, Airtel, MTN

Ukraine	BRN314	2G, 3G	Kyivstar, Life, MTS
United Kingdom	BRN314	2G, 3G	3, EE, Manx, O2, Sure, Vodafone
United States	BRN404	M1	AT&T, T-Mobile (USA), Verizon ⁷
United States	BRN404X	M1	AT&T, T-Mobile (USA), Verizon ⁷
Uruguay	BRN314	2G, 3G	Antel, Claro, Movistar
Uzbekistan	BRN314	2G, 3G	Beeline
Venezuela	BRN314	2G, 3G	Movistar
Vietnam	BRN314	2G, 3G	MobiFone, Viettel, Vinaphone
Virgin Islands (British)	BRN314	2G, 3G	CCT, Flow
Zambia	BRN314	2G, 3G	Airtel

⁷Verizon in the United States is only supported on enterprise plans.

Ordering information

Borons are available from store.particle.io in single quantities in 2G/3G and LTE Cat M1 versions.

SKU	Description	Region	Modem	EtherSIM	Lifecycle	Replacement
BRN404X	Boron LTE CAT-M1 (NorAm), [x1]	NORAM	R510	✓	GA	
BRN404XKIT	Boron LTE CAT-M1 (NorAm, EtherSIM), Starter Kit [x1]	NORAM	R510	✓	GA	
BRN404XTRAY50	Boron LTE CAT-M1 (NorAm), Tray [x50]	NORAM	R510	✓	GA	
BRN310TRAY50	Boron 2G/3G (Global), Tray [x50]	Global	U201		NRND	
BRN314TRAY50	Boron 2G/3G (Global), Tray [x50]	Global	U201	✓	NRND	
BRN402TRAY50	Boron LTE CAT-M1 (NorAm), Tray [x50]	NORAM	R410		NRND	BRN404XTRAY50
BRN310KIT	Boron 2G/3G (Global) Starter Kit, [x1]	Global	U201		Deprecated	
BRN314KIT	Boron 2G/3G (Global) Starter Kit, [x1]	Global	U201	✓	Deprecated	
BRN402	Boron LTE CAT-M1 (NorAm), [x1]	NORAM	R410		Deprecated	BRN404X
BRN402-AQKT	Boron LTE CAT-M1 (NorAm) Air Quality Monitor Kit, [x1]	NORAM	R410		Deprecated	
BRN402KIT	Boron LTE CAT-M1 (NorAm), Starter Kit [x1]	NORAM	R410		Deprecated	BRN404XKIT
BRN404	Boron LTE CAT-M1 (NorAm), [x1]	NORAM	R410	✓	Deprecated	BRN404X
BRN404KIT	Boron LTE CAT-M1 (NorAm, EtherSIM), Starter Kit [x1]	NORAM	R410	✓	Deprecated	BRN404XKIT
BRN404TRAY50	Boron LTE CAT-M1 (NorAm, EtherSIM), Tray [x50]	NORAM	R410	✓	Deprecated	BRN404XTRAY50

Qualification and approvals



**BORON LTE (Cat M1) **

- Model Number: BRN404, BRN402
- RoHS
- CE
- PTCRB
- FCC ID: 2AEMI-BRN402
- ISED: 20127-BRN402

BORON 2G/3G

- Model Number: BRN314, BRN310
- RoHS
- CE
- FCC ID: 2AEMI-BRN310
- ISED: 20127-BRN310

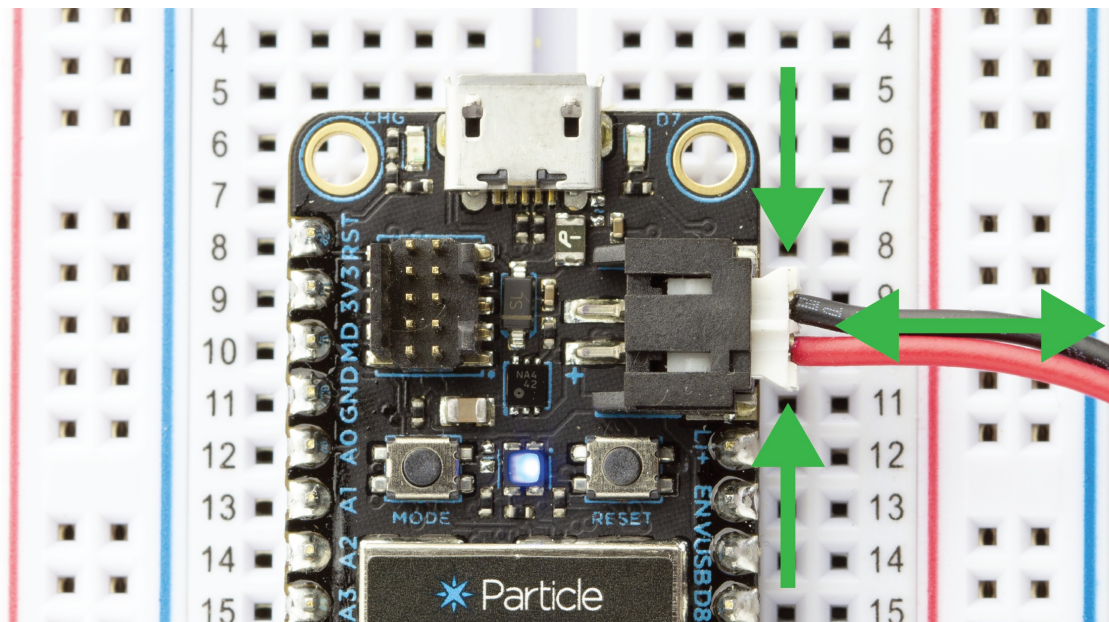
Product handling

ESD PRECAUTIONS

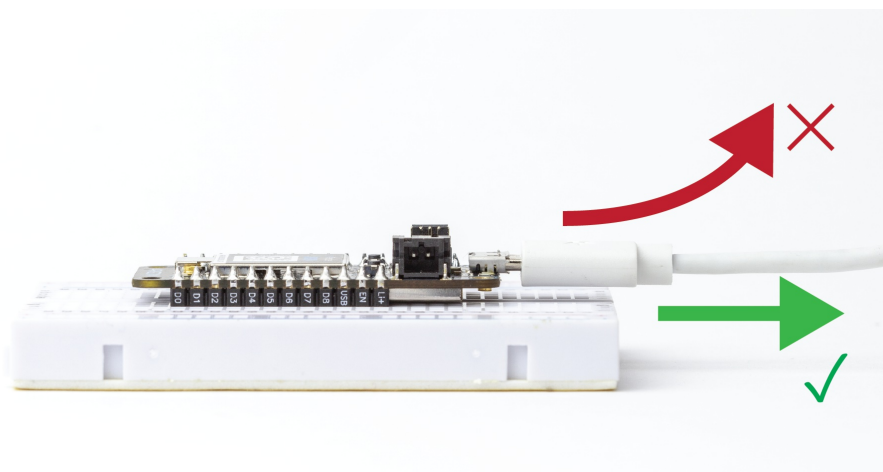
The Boron contains highly sensitive electronic circuitry and is an Electrostatic Sensitive Device (ESD). Handling Boron without proper ESD protection may destroy or damage it permanently. Proper ESD handling and packaging procedures must be applied throughout the processing, handling and operation of any application that incorporates Boron. ESD precautions should be implemented on the application board where the Boron is mounted. Failure to observe these precautions can result in severe damage to the Boron!

CONNECTORS

There are four connectors on the Boron that will get damaged with improper usage. The JST connector on the circuit board, where you plug in the LiPo battery, is very durable but the connector on the battery itself is not. When unplugging the battery, take extra precaution to **NOT** pull the connector using the wires, but instead hold the plug at its base to avoid putting stress on the wires. This can be tricky with bare hands - nose pliers are your friend here.



The micro B USB connector on the Boron is soldered on the PCB with large surface pads as well as a couple of through hole anchor points. Despite this reinforcement, it is very easy to rip out the connector if too much stress is put on in the vertical direction.



The U.FL antenna connector is not designed to be constantly plugged and unplugged. The antenna pin is static sensitive and you can destroy the radio with improper handling. A tiny dab of

glue (epoxy, rubber cement, liquid tape or hot glue) on the connector can be used securely hold the plug in place.

The 10 pin SWD connector provides an easy in-system debugging access to the device. The pins on the connector can easily be damaged if the mating connector cable is inserted improperly. If you are trying to debug the device, you probably are not in a good mood to begin with. The last thing you want is to render the connector useless. Be nice, and be gentle on the connector. Good luck with the debugging!

BREADBOARDING

The breadboard provided with the Boron is specifically designed to require low insertion force. This makes it easy to plug the Boron in and out of the breadboard. If you end up using a different breadboard, remember that it may require more force. In this case, always remember to pinch-hold your precious Boron by the sides (along the header pins) when plugging-unplugging and not by the USB connector (don't be this person).

Default settings

The Boron comes preprogrammed with a bootloader and a user application called Tinker. This application works with an iOS and Android app also named Tinker that allows you to very easily toggle digital pins, take analog and digital readings and drive variable PWM outputs.

The bootloader allows you to easily update the user application via several different methods, USB, OTA, Serial Y-Modem, and also internally via the Factory Reset procedure. All of these methods have multiple tools associated with them as well.

FCC ISED CE warnings and end product labeling requirements

Federal Communication Commission Interference Statement This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

FCC Caution: Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate this equipment. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

1. This device may not cause harmful interference, and
2. This device must accept any interference received, including interference that may cause undesired operation.

FCC Radiation Exposure Statement: This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This transmitter module must not be co-located or operating in conjunction with any other antenna or transmitter. This End equipment should be installed and operated with a minimum distance of 20 centimeters between the radiator and your body.

IMPORTANT NOTE: In the event that these conditions can not be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

End Product Labeling The final end product must be labeled in a visible area with the following:

- Contains FCC ID: 2AEMI-BRN402 (BORON LTE)
- Contains FCC ID: 2AEMI-BRN310 (BORON 2G/3G)

Manual Information to the End User The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module.

Canada Statement This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions:

1. This device may not cause interference; and
2. This device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence.

L'exploitation est autorisée aux deux conditions suivantes:

1. l'appareil ne doit pas produire de brouillage;
2. l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Caution Exposure: This device meets the exemption from the routine evaluation limits in section 2.5 of RSS102 and users can obtain Canadian information on RF exposure and compliance. Le dispositif répond à l'exemption des limites d'évaluation de routine dans la section 2.5 de RSS102 et les utilisateurs peuvent obtenir des renseignements canadiens sur l'exposition aux RF et le respect.

The final end product must be labelled in a visible area with the following: The Industry Canada certification label of a module shall be clearly visible at all times when installed in the host device, otherwise the host device must be labelled to display the Industry Canada certification number of the module, preceded by the words "Contains transmitter module", or the word "Contains", or similar wording expressing the same meaning, as follows:

- Contains transmitter module ISED: 20127-BRN402 (BORON LTE)
- Contains transmitter module ISED: 20127-BRN310 (BORON 2G/3G)

This End equipment should be installed and operated with a minimum distance of 20 centimeters between the radiator and your body. Cet équipement devrait être installé et actionné avec une distance minimum de 20 centimètres entre le radiateur et votre corps.

The end user manual shall include all required regulatory information/warning as shown in this manual.

Revision history

Revision	Date	Author	Comments
v001	2018 Oct 26	MB	Initial release
v002	2020 Jan 21	RK	Remove mesh
v003	2020 Sep 01	RK	Add EN pin information
v004	16-Sep-2020	RK	Added power consumption information
v005	15-Mar-2021	RK	Updated model, carrier, ordering information
v005	26-Apr-2021	RK	Added BRN314 and BRN404 model numbers
v006	28-Jun-2021	RK	Added Device OS 3.1 memory map information
v007	09-Jul-2021	RK	Number of accessible I2C ports is 1, not 2
v008	28-Jul-2021	RK	Corrected number of SPI ports (2) in peripherals and GPIO
v009	10-Sep-2021	RK	Changed wording of peak vs. max current
v010	06-Sep-2022	RK	Split BRN404X into new datasheet
v011	28-Apr-2023	RK	Add conformal coating and flux notes
v012	19-Mar-2024	RK	Incorrect bands listed for the BRN402 and BRN404

Known errata

Contact

Web

<https://www.particle.io>

Community Forums

<https://community.particle.io>